

**AMENDMENTS TO THE SPECIFICATION**

In the Specification, first paragraph, please amend as follows:

- 5           -- This application is continuation-in-part of U.S. Patent Application Serial No. 10/463,525, entitled "METHOD AND APPARATUS FOR APPLYING DIFFERENTIAL REMOVAL RATES TO A SURFACE OF A SUBSTRATE," filed on June 18, 2003 ~~June 30, 2003~~ which is a continuation in part of U.S. Patent Application Serial No. 10/186,472, entitled "INTEGRATION OF EDDY CURRENT SENSOR
- 10   BASED METROLOGY WITH SEMICONDUCTOR FABRICATION TOOLS," filed on June 28, 2002. The disclosure of these Patent Applications are incorporated herein by reference.--